S6BP202A

ASSP, 42V, 2.4A, Synchronous Buck-boost DC/DC Converter IC

S6BP202A is a 1-Ch Buck-boost DC/DC converter IC with four built-in switching FETs. This IC is able to supply up to 2.4A of load current within the very wide range from 2.5V to 42V in the input voltage. This IC has an operation mode that is automatically changed to PFM operation during low load, which can achieve super-high efficiency with a very low quiescent current 20 µA. It is possible to provide stable output voltage from an automotive cold cranking and load dump, up to 42V, conditions within 1 ms transition time. As a result, this IC is suitable for power supply solutions of automotive and Industrial applications. This IC has the SYNC function, which is capable of selecting the SYNC_IN that is able to inputs an external clock signal or the SYNC_OUT that is able to output an internal clock. When selecting the SYNC_IN and an external clock signal in the range from 200 kHz to 400 kHz is inputted, the FETs perform the switching operation with synchronizing signal from an external clock. When selecting the SYNC_IN and an external clock signal is not inputted, the FETs perform the switching operation from an internal clock. When selecting the SYNC_OUT, this IC provides a clock signal generated inside to external devices. The internal clock signal in the range from 200 kHz to 2.1 MHz can be set by an external resistor. Since external voltage setting resistors and phase compensation capacitors are not required with this IC, it can reduce the number of parts and a part mounting area. This IC has five protection functions, input under voltage lockout (input UVLO), output under voltage protection (output UVP), output over voltage protection (output OVP), output over current protection (output OCP), and thermal shutdown (TSD). Moreover, this IC has the power good (PG) function that indicates the state of the output voltage (VOUT pin). When the output voltage reaches the PG voltage, the PG signal is outputted. Also, the power-on reset time for the PG signal is selectable. The VOUT output voltage, SYNC function, VOUT UVP threshold, VOUT OVP threshold, power-on reset time of this product are selectable from the product lineup (refer to the "1. Product Lineup").

Features

- Wide input voltage range: 2.5V to 42V
- Selectable output voltage (factory settable):
  5.000V/5.050V/5.075V/5.100V/5.125V/5.150V/5.200V
- Wide operating frequency range: 200 kHz to 2.1 MHz
- External synchronized clock range: 200 kHz to 400 kHz
- SYNC function (factory settable)
  □ SYNC_IN: External clock input
  (Unless inputting clock, this IC operates by internal clock)
  □ SYNC_OUT: Internal clock output
- Super-high efficiency by PFM operation
  (When setting MODE pin to a low level)
- Automatic PWM/PFM switching operation and fixed PWM operation are selectable by MODE pin
- Built-in switching FET
- Synchronous current mode architecture
- Shutdown current: Lower than 1 µA
- Quiescent current: 20 µA
- Power Good Monitor
  □ Output voltage monitoring by window comparator
  □ Power-on reset time (factory settable): 7 µs, 14 ms
- Soft start time without load dependence: 0.9 ms
  (When switching frequency = 2.1 MHz)
- Enhanced protection functions
  □ Input UVLO
  □ Output UVP (factory settable): 92.0%, 95.5%
  □ Output OVP (factory settable): 108.0%, 104.5%
  □ Output OVC
  □ Thermal shutdown
- Small ETSSOP16 package (exposed PAD): 5 mm × 6.4 mm
- AEC-Q100 compliant (Grade-1)

Applications

- Instrument cluster
- Advanced driver assistance systems (ADAS)
- Gateway module
- Automotive applications
- Industrial applications

Block Diagram
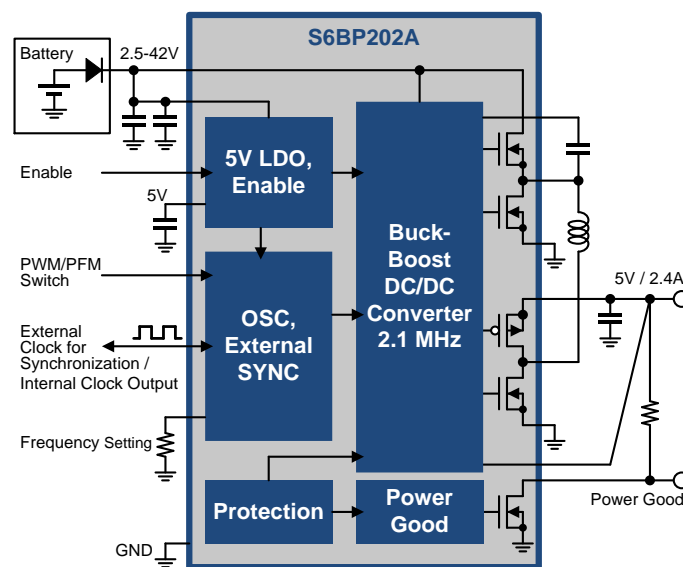
More Information

Cypress provides a wealth of data at www.cypress.com/pmic to help you to select the right PMIC device for your design, and to help you to quickly and effectively integrate the device into your design. Following is an abbreviated list for S6BP202A.

- Overview: Automotive PMIC Portfolio, Automotive PMIC Roadmap
- Product Selector:
  - □ S6BP202A:
    1-Ch Buck-Boost Automotive PMIC
- Application Notes: Cypress offers S6BP202A application notes. Recommended application notes for getting started with S6BP202A are:
  - □ AN99497: Designing a Power Management System with S6BP201A, S6BP202A, and S6BP203A
  - □ AN201006: Thermal Considerations and Parameters

- Evaluation Kit Operation Manual:
  - □ S6SBP202A1FVA1001:
    Power block of automotive instrument cluster
- Related Products:
  - □ S6BP201A, S6BP203A:
    1-Ch Buck-Boost Automotive PMIC
  - □ S6BP401A:
    6-Ch Automotive PMIC for ADAS
  - □ S6BP501A, S6BP502A:
    3-Ch Automotive PMIC for Instrument Cluster

Contents

1. Product Lineup

The VOUT output voltage, SYNC function, VOUT UVP threshold, VOUT OVP threshold, power-on reset time of this product are set at the factory shipment. To order a product, select an item from the product lineup blow.
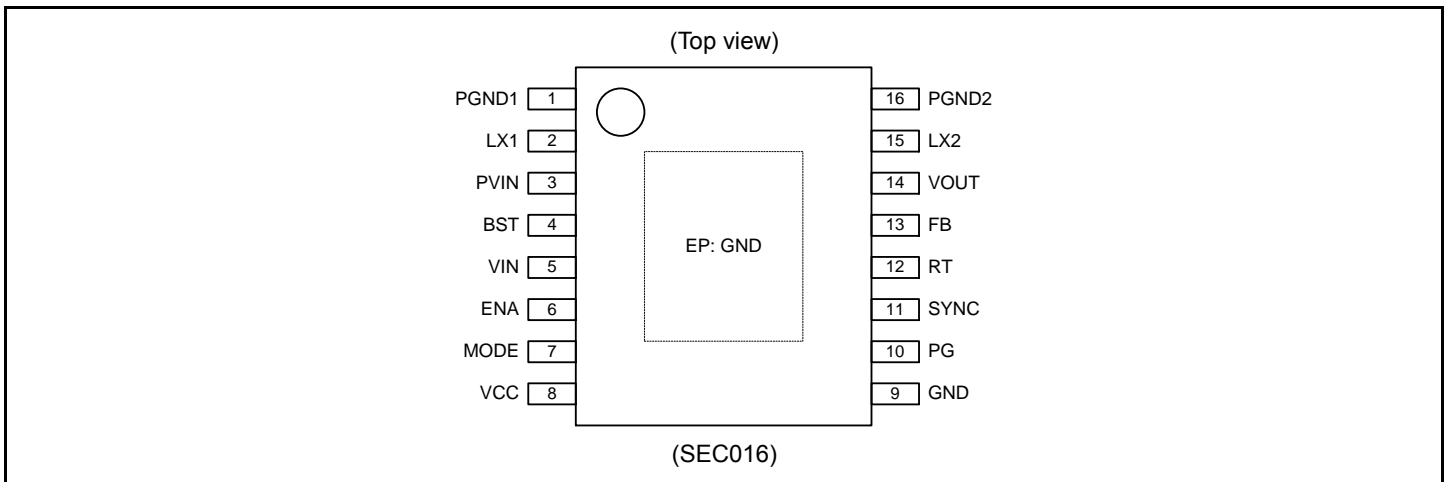
Part Number (MPN)	Order Code	VOUT Output Voltage [V]	SYNC Function	VOUT UVP Threshold [%]		VOUT OVP Threshold [%]		Power-on Reset Time[s]
				Falling (Typ)	Rising(Typ)	Rising (Typ)	Falling (Typ)	
S6BP202A1BST2B00A	1B	5.000	SYNC_IN	92.0	93.0	108.0	107.0	7.0µ
S6BP202A1CST2B00A	1C		SYNC_OUT					
S6BP202A1DST2B00A	1D		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A1EST2B00A	1E		SYNC_OUT					
S6BP202A1FST2B00A	1F		SYNC_IN	92.0	93.0	108.0	107.0	14.0m
S6BP202A1GST2B00A	1G		SYNC_OUT					
S6BP202A1HST2B00A	1H		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A1JST2B00A	1J		SYNC_OUT					
S6BP202A2BST2B00A	2B	5.050	SYNC_IN	92.0	93.0	108.0	107.0	7.0µ
S6BP202A2CST2B00A	2C		SYNC_OUT					
S6BP202A2DST2B00A	2D		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A2EST2B00A	2E		SYNC_OUT					
S6BP202A2FST2B00A	2F		SYNC_IN	92.0	93.0	108.0	107.0	14.0m
S6BP202A2GST2B00A	2G		SYNC_OUT					
S6BP202A2HST2B00A	2H		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A2JST2B00A	2J		SYNC_OUT					
S6BP202A3BST2B00A	3B	5.075	SYNC_IN	92.0	93.0	108.0	107.0	7.0µ
S6BP202A3CST2B00A	3C		SYNC_OUT					
S6BP202A3DST2B00A	3D		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A3EST2B00A	3E		SYNC_OUT					
S6BP202A3FST2B00A	3F		SYNC_IN	92.0	93.0	108.0	107.0	14.0m
S6BP202A3GST2B00A	3G		SYNC_OUT					
S6BP202A3HST2B00A	3H		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A3JST2B00A	3J		SYNC_OUT					
S6BP202A4BST2B00A	4B	5.100	SYNC_IN	92.0	93.0	108.0	107.0	7.0µ
S6BP202A4CST2B00A	4C		SYNC_OUT					
S6BP202A4DST2B00A	4D		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A4EST2B00A	4E		SYNC_OUT					
S6BP202A4FST2B00A	4F		SYNC_IN	92.0	93.0	108.0	107.0	14.0m
S6BP202A4GST2B00A	4G		SYNC_OUT					
S6BP202A4HST2B00A	4H		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A4JST2B00A	4J		SYNC_OUT					
S6BP202A5BST2B00A	5B	5.125	SYNC_IN	92.0	93.0	108.0	107.0	7.0µ
S6BP202A5CST2B00A	5C		SYNC_OUT					
S6BP202A5DST2B00A	5D		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A5EST2B00A	5E		SYNC_OUT					
S6BP202A5FST2B00A	5F		SYNC_IN	92.0	93.0	108.0	107.0	14.0m
S6BP202A5GST2B00A	5G		SYNC_OUT					
S6BP202A5HST2B00A	5H		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A5JST2B00A	5J		SYNC_OUT					
S6BP202A6BST2B00A	6B	5.150	SYNC_IN	92.0	93.0	108.0	107.0	7.0µ
S6BP202A6CST2B00A	6C		SYNC_OUT					
S6BP202A6DST2B00A	6D		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A6EST2B00A	6E		SYNC_OUT					
S6BP202A6FST2B00A	6F		SYNC_IN	92.0	93.0	108.0	107.0	14.0m
S6BP202A6GST2B00A	6G		SYNC_OUT					
S6BP202A6HST2B00A	6H		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A6JST2B00A	6J		SYNC_OUT					

Part Number (MPN)	Order Code	VOUT Output Voltage [V]	SYNC Function	VOUT UVP Threshold [%]		VOUT OVP Threshold [%]		Power-on Reset Time[s]
				Falling (Typ)	Rising(Typ)	Rising (Typ)	Falling (Typ)	
S6BP202A7BST2B00A	7B	5.200	SYNC_IN	92.0	93.0	108.0	107.0	7.0μ
S6BP202A7CST2B00A	7C		SYNC_OUT					
S6BP202A7DST2B00A	7D		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A7EST2B00A	7E		SYNC_OUT					
S6BP202A7FST2B00A	7F		SYNC_IN	92.0	93.0	108.0	107.0	14.0m
S6BP202A7GST2B00A	7G		SYNC_OUT					
S6BP202A7HST2B00A	7H		SYNC_IN	95.5	96.5	104.5	103.5	
S6BP202A7JST2B00A	7J		SYNC_OUT					

MPN: Marketing Part Number

2. Pin Assignment

Figure 2-1 Pin Assignment

(Top view)

PGND1	1		16	PGND2
LX1	2		15	LX2
PVIN	3		14	VOUT
BST	4		13	FB
VIN	5	EP: GND	12	RT
ENA	6		11	SYNC
MODE	7		10	PG
VCC	8		9	GND

(SEC016)

3. Pin Descriptions

Table 3-1 Pin Descriptions

Pin No.	Pin Name	I/O	Description
1	PGND1	−	GND pin for built-in switching FET
2	LX1	O	Inductor connection pin
3	PVIN	I	Power supply pin for PWM controller and switching FETs
4	BST	I	BST(Boost) capacitor connection pin
5	VIN	I	Power supply pin
6	ENA	I	DC/DC converter enable pin
7	MODE	I	PWM/PFM operation control pin
8	VCC	O	VCC capacitor connection pin. LDO output pin of Internal reference voltage
9	GND	−	GND pin
10	PG	O	Open drain output pin for power good. When being used, connect PG pin to VCC pin or VOUT pin. When not being used, leave PG pin open.
11	SYNC	I/O	External clock input pin / Internal clock output pin. For the SYNC pin setting, refer to "10.1 Setting the Operation Conditions"
12	RT	O	Timing resistor connection pin for internal clock (switching frequency). For the resistance, refer to "10.1 Setting the Operation Conditions"
13	FB	I	Output voltage feedback pin
14	VOUT	O	DC/DC converter output pin
15	LX2	O	Inductor connection output pin.
16	PGND2	−	GND pin for built-in switching FET
EP	GND	−	GND pin

Figure 3-1 I/O Pin Equivalent Circuit Diagram
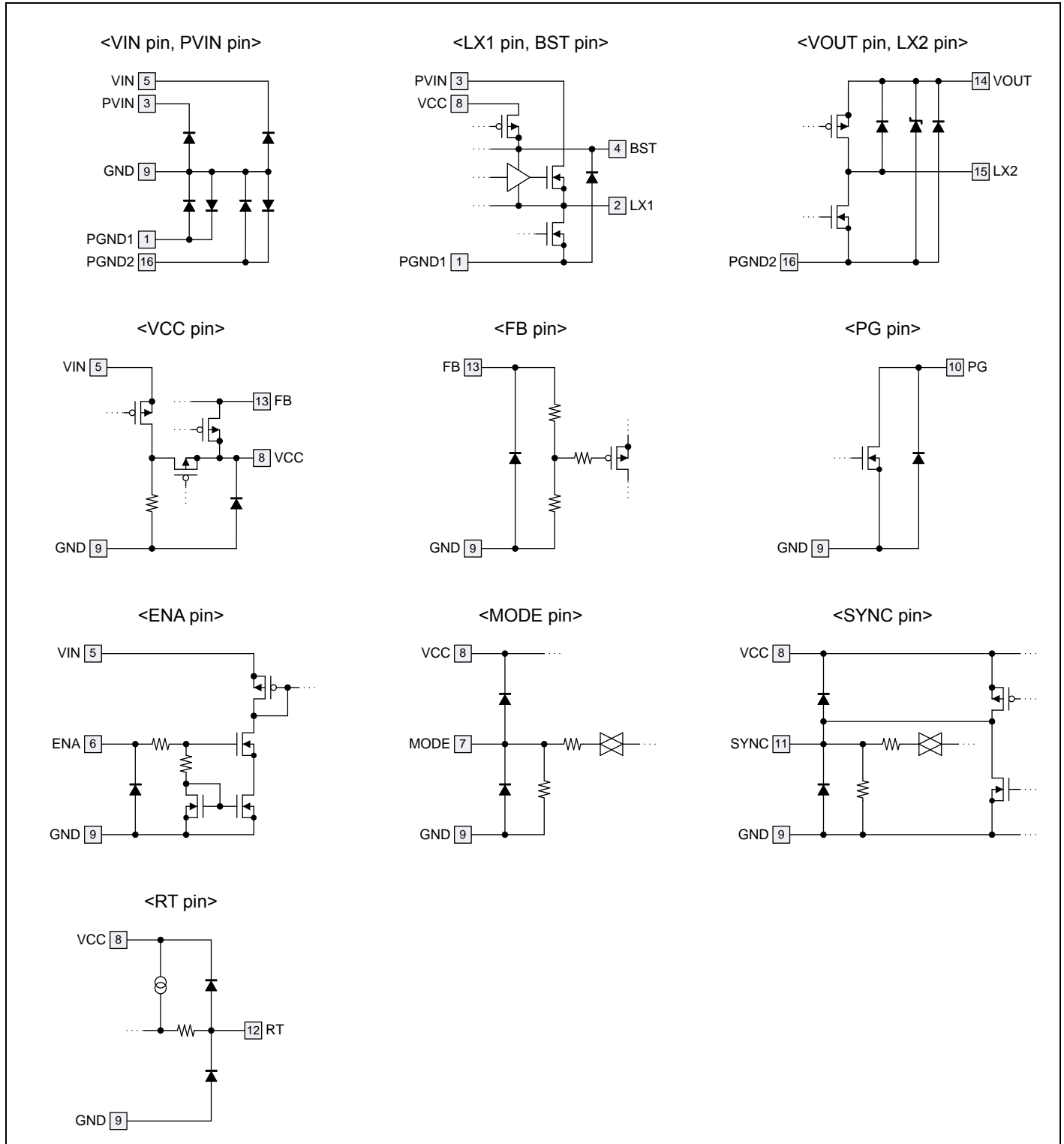
4. Architecture Block Diagram

Figure 4-1 Architecture Block Diagram
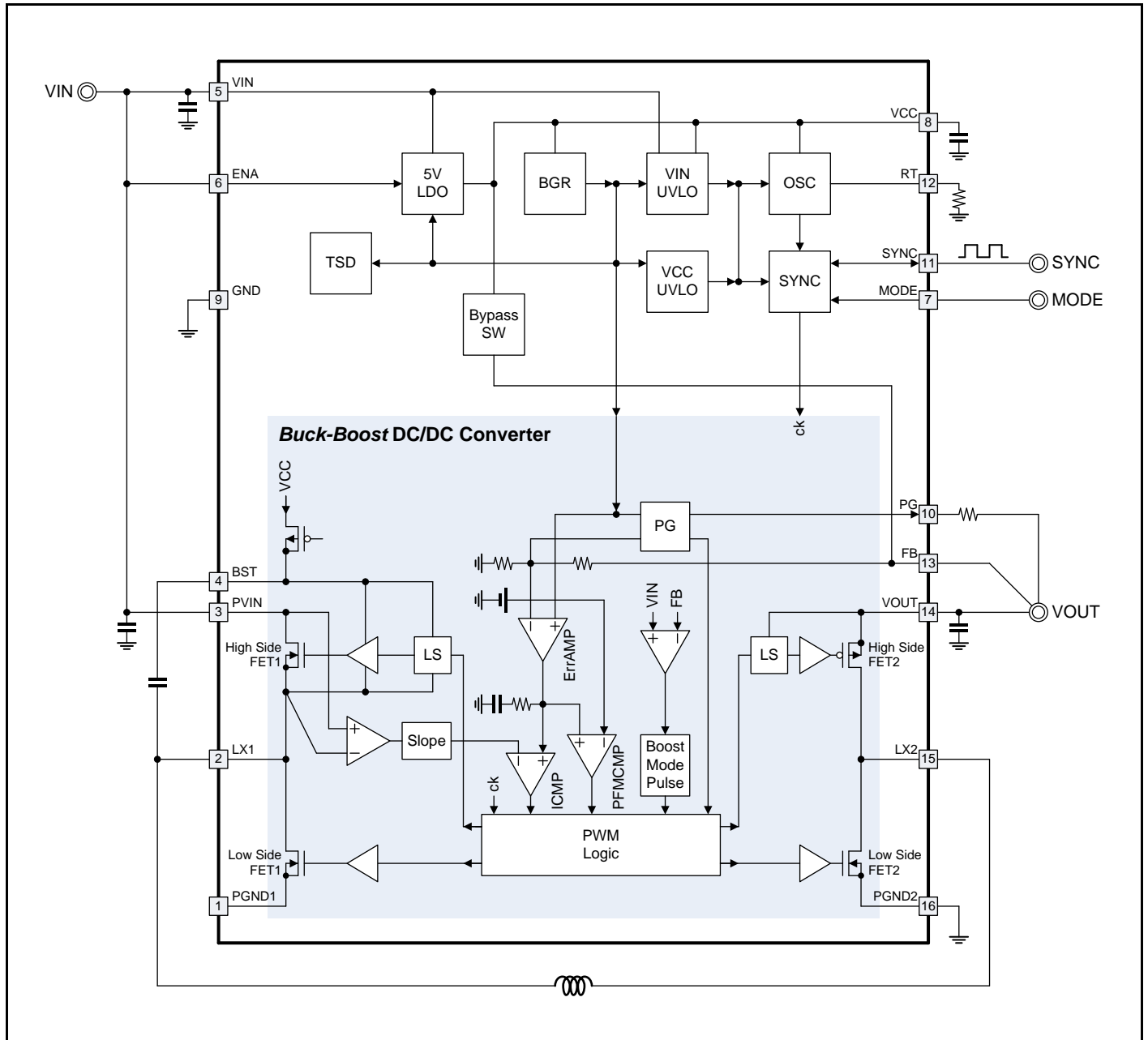
5. Absolute Maximum Ratings

Parameter	Symbol	Condition	Rating		Unit
			Min	Max	
Power supply voltage (*1)	V_{VIN}	VIN pin	−0.3	+48.0	V
	V_{PVIN}	PVIN pin	−0.3	+48.0	V
	V_{VCC}	VCC pin	−0.3	+6.9	V
Terminal voltage(*1)	V_{BST}	BST pin	−0.3	+48.0	V
	V_{LX1}	LX1 pin	−2.0	+48.0	V
	V_{LX2}	LX2 pin	−2.0	+6.9	V
	V_{FB}	FB pin	−0.3	V_{VCC}	V
	V_{RT}	RT pin	−0.3	V_{VCC}	V
	V_{MODE}	MODE pin	−0.3	V_{VCC}	V
	V_{SYNC}	SYNC pin	−0.3	V_{VCC}	V
	V_{ENA}	ENA pin	−0.3	+48.0	V
	V_{PG}	PG pin	−0.3	+6.9	V
Difference voltage(*1)	V_{BST-LX}	Between BST–LX1 pins	−0.3	+6.9	V
	V_{GND}	Between GND–PGND1 pins, Between GND–PGND2 pins	−0.3	+0.3	V
PG output current	I_{PG}	PG pin	−3	0	mA
Power dissipation (*1)	P_D	Ta ≤ ±25°C	0	3324 (*2)	mW
Storage temperature	T_{STG}	−	−55	+150	°C

*1: When PGND1 = PGND2 = GND = 0V

*2: When the product is mounted on 76.2 mm × 114.3 mm, four-layer FR-4 board

Warning:

1. *Semiconductor devices may be permanently damaged by application of stress (including, without limitation, voltage, current or temperature) in excess of absolute maximum ratings. Do not exceed any of these ratings.*

6. Recommended Operating Conditions

Parameter	Symbol	Condition		Value			Unit
				Min	Typ	Max	
Power supply voltage (*1)	V_{VIN}	VIN pin	At start-up	5.0	12.0	42.0	V
			After start-up	2.5	12.0	42.0	V
Terminal voltage (*1)	V_{BST}	BST pin		0.0	−	47.5	V
	V_{LX1}	LX1 pin		−1.0	+12.0	+42.0	V
	V_{LX2}	LX2 pin		−1.0	−	+5.5	V
	V_{FB}	FB pin		0.0	−	5.5	V
	V_{MODE}	MODE pin		0.0	−	5.5	V
	V_{SYNC}	SYNC pin		0.0	−	5.5	V
	V_{ENA}	ENA pin		0.0	12.0	42.0	V
	V_{PG}	PG pin		0.0	−	5.5	V
Difference voltage(*1)	$V_{BST-LX1}$	Between BST−LX1 pins		0.0	−	5.5	V
	V_{GND}	Between GND−PGND1 pins,Between GND−PGND2 pins		−0.05	0.00	+0.05	V
PG output current	I_{PG}	PG pin (sink current)		0	−	1	mA
BST capacitance	C_{BST}	Between BST−LX1 pins		0.068	0.100	0.470	μF
VCC capacitance	C_{VCC}	Between VCC−GND pins		2.2	4.7	10.0	μF
Timing resistance	R_{RT}	Between RT−GND pins. When using internal clock		22	−	270	kΩ
Operating ambient Temperature	Ta	−		−40	+25	+125	°C

*1: When PGND1 = PGND2 = GND = 0V

Warning:

1. *The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated under these conditions.*

2. *Any use of semiconductor devices will be under their recommended operating condition.*

3. *Operation under any conditions other than these conditions may adversely affect reliability of device and could result in device failure.*

4. *No warranty is made with respect to any use, operating conditions or combinations not represented on this data sheet. If you are considering application under any conditions other than listed herein, please contact sales representatives beforehand.*

7. Electrical Characteristics

VIN=PVIN=12V, ENA=5V

(Unless specified otherwise, these are the electrical characteristics under the recommended operating environment.)

Parameter		Symbol	Condition	Value			Unit
				Min	Typ	Max	
Buck-boost DC/DC converter Block	VOUT output voltage	V$_{VOUT}$	I$_{VOUT}$ = 0A, When V$_{VOUT}$ = 5.000 (*1)	4.925	5.000	5.075	V
			I$_{VOUT}$ = 0A, When V$_{VOUT}$ = 5.050 (*1)	4.975	5.050	5.125	V
			I$_{VOUT}$ = 0A, When V$_{VOUT}$ = 5.075 (*1)	4.999	5.075	5.151	V
			I$_{VOUT}$ = 0A, When V$_{VOUT}$ = 5.100 (*1)	5.024	5.100	5.176	V
			I$_{VOUT}$ = 0A, When V$_{VOUT}$ = 5.125 (*1)	5.048	5.125	5.201	V
			I$_{VOUT}$ = 0A, When V$_{VOUT}$ = 5.150 (*1)	5.073	5.150	5.227	V
			I$_{VOUT}$ = 0A, When V$_{VOUT}$ = 5.200 (*1)	5.122	5.200	5.278	V
	FB input resistance	R$_{FB}$	EN = 0V, Ta = +25°C	3.84	4.80	5.76	MΩ
	Switching FET on-resistance	R$_{HSIDEFET1}$	LX1 = −30 mA (Between PVIN−LX1)	−	150	−	mΩ
		R$_{LSIDEFET1}$	LX1 = 30 mA (Between LX1−PGND1)	−	150	−	mΩ
		R$_{HSIDEFET2}$	LX2 = −30 mA (Between VOUT−LX2)	−	150	−	mΩ
		R$_{LSIDEFET2}$	LX2 = 30 mA (Between LX2−PGND2)	−	150	−	mΩ
	switching FET leakage current	I$_{LEAK}$	−	−	−	5	µA
	Soft-start time	T$_{SS}$	R$_{RT}$ = 22 kΩ	0.855	0.9	0.945	ms
	Maximum output current	I$_{VOUT}$	PVIN ≥ 7.5V, Ta = 25 °C	2.4 (*2)	−	−	A
			PVIN = 4.5V, Ta = 25 °C	1.0 (*2)	−	−	A
	Current limit	I$_{LIMT}$	PVIN = 12V, L = 2.2 µH	2.4 (*2)	−	−	A
5V LDO block	VCC output voltage	V$_{VCC}$	VIN = 12V	4.9	5.0	5.1	V
VIN UVLO block	VIN UVLO falling threshold	V$_{UVLOVINHL}$	VIN input voltage when falling	2.30	2.40	2.50	V
	VIN UVLO rising threshold	V$_{UVLOVINLH}$	VIN input voltage when rising	4.55	4.75	4.95	V
VCC UVLO block	VCC UVLO falling threshold	V$_{UVLOVCCHL}$	VCC input voltage when falling	2.30	2.40	2.50	V
	VCC UVLO rising threshold	V$_{UVLOVCCLH}$	VCC input voltage when rising	4.55	4.75	4.95	V
ENA pin	Enable condition	V$_{ENA}$	Enable voltage range	1.10	−	V$_{VIN}$	V
		V$_{DSB}$	Disable voltage range	0.0	−	0.2	V
	ENA input current	I$_{ENA}$	V$_{ENA}$ = 12V	−	1	3	µA
MODE pin	MODE input voltage	V$_{MODE\_L}$	Automatic PWM/PFM switching	0.0	−	0.4	V
		V$_{MODE\_H}$	Fixed PWM operation	2.0	−	V$_{VOUT}$	V
	MODE Input current	I$_{MODE}$	MODE = 5.0V	−	5	10	µA
OSC block	Switching frequency (SYNC output frequency)	F$_{OSC}$	R$_{RT}$ = 22kΩ	2.0	2.1	2.2	MHz
			R$_{RT}$ = 270kΩ	180	200	220	kHz
SYNC block (SYNC_IN/ SYNC_OUT)	SYNC input threshold	V$_{SYNC\_L}$	When selecting SYNC_IN (*1)	0.0	−	0.4	V
		V$_{SYNC\_H}$	When selecting SYNC_IN (*1)	2.0	−	V$_{VOUT}$	V
	SYNC input frequency	V$_{SYNC\_L}$	When selecting SYNC_IN (*1)	200	−	400	kHz
	SYNC input duty ratio	V$_{SYNC\_H}$	When selecting SYNC_IN (*1)	+20	+50	+80	%
	SYNC output frequency	F$_{OUTPUT}$	When selecting SYNC_OUT (*1)	−	F$_{OSC}$	−	Hz
	SYNC output duty ratio	F$_{OUTDUTY}$	When selecting SYNC_OUT (*1)	+40	+50	+60	%
	SYNC leakage current	I$_{LKSYNC}$	V$_{SYNC}$ = 5.0V, When selecting SYNC_IN (*1)	−	5	10	µA
PG block (UVP, OVP)	VOUT UVP falling threshold	P$_{GUVPHL}$	Falling threshold for VOUT output voltage setting (*1)	90.5	92.0	93.5	%
				94.0	95.5	97.0	%
	VOUT UVP rising threshold	P$_{GUVPLH}$	Rising threshold for VOUT output voltage setting (*1)	91.5	93.0	94.5	%
				95.0	96.5	98.0	%
	VOUT OVP rising threshold	P$_{GOVPLH}$	Rising threshold for VOUT output voltage setting (*1)	106.5	108.0	109.5	%
				103.0	104.5	106.0	%
	VOUT OVP falling threshold	P$_{GOVPHL}$	Falling threshold for VOUT output voltage setting (*1)	105.5	107.0	108.5	%
				102.0	103.5	105.0	%
	Leak current	I$_{LKPG}$	V$_{PWRGD}$ = 5.0V, V$_{ENA}$ = 0V	0	−	1	µA
	Low level output voltage	V$_{OLPG}$	I$_{PGSINK}$ = 1 mA	0.025	0.05	0.15	V
	Delay time at abnormal detection	T$_{PPG}$	At power shutdown	−	7(*2)	12(*2)	µs
	Power-on reset time (*1)	T$_{RPG}$	At power good	−	7(*2)	12(*2)	µs
				9.1	14.0	18.9	ms

Parameter		Symbol	Condition	Value			Unit
				Min	Typ	Max	
Thermal shutdown block (TSD)	Shutdown temperature	T$_{TSDH}$	–	–	165 (*2)	–	°C
		T$_{TSDL}$	Hysteresis	–	10 (*2)	–	°C
Supply current	Shutdown current	I$_{VINSDN}$	VIN input current, V$_{ENA}$ = 0V	–	1	5	µA
	Quiescent current	I$_{VINQ}$	VIN input current, V$_{ENA}$ = 12V, I$_{VOUT}$ = 0A, MODE/SYNC/PG Pins = OPEN	–	20	40	µA

*1: Refer to "1. Product Lineup"

*2: The electrical characteristic is ensured by statistical characterization and indirect tests.

8. Functional Description

8.1 Block Description

Input Under Voltage Lockout (Input UVLO)

The input UVLO is the function that prevents a malfunction of this IC from the following status, and protects poststage devices.

▢ Transitional state at start-up
▢ Momentary drop of power supply voltage

To prevent such a malfunction, this protection monitors the VIN input voltage and VCC voltage. When either VIN or VCC voltage falls to the UVLO falling threshold, 2.4V (Typ), or lower, the IC stops the VOUT voltage output and becomes UVLO status. When both VIN and VCC voltages reach the UVLO rising threshold, 4.75V (Typ), or higher, the IC is released from the UVLO state and returns to the normal operation.

Output Under Voltage Protection (Output UVP)

The output UVP is the function that monitors the voltage drop of the VOUT pin and notifies by the PG pin.

When the output voltage falls to the UVP falling threshold (P$_{GUVPHL}$) for the output voltage setting or lower, the PG voltage is fixed to the low level. The IC becomes the UVP status, but the switching operation is maintained under the UVP status.

When the output voltage once again reaches the UVP rising threshold (P$_{GUVPLH}$) for the output voltage setting or higher, the IC is released from the UVP state and the PG voltage is fixed to the high level.

Output Over Voltage Protection (Output OVP)

The output OVP is the function that monitors the voltage rise of the VOUT pin and stops the switching operations, which protects poststage devices from overvoltage. Also, the VOUT state is notified by the PG pin.

When the output voltage rises to the OVP falling threshold (P$_{GOVPLH}$) for the output voltage setting or higher, the PG voltage is fixed to the low level. The IC becomes the OVP status, and the switching operations of the high-Side FETs are stopped. When the output voltage once again falls to the OVP falling threshold (P$_{GOVPHL}$) for the output voltage setting or lower, the IC is released from the OVP state and resumes the switching operations. The PG voltage is fixed to the high level again.

Output Over Current Protection (Output OCP)

The output OCP is the function that limits the excessive current load and protects poststage devices.

Thermal Shutdown (TSD)

The TSD is the function that protects the IC from heat-destruction. When the junction temperature reaches +165°C (Typ), the high-side and low-side switching FET are turned off and the IC becomes the TSD status. When the junction temperature once again falls to +155°C (Typ) or lower, the IC is released from the TSD state and restarts the power supply.

8.2 Protection Function Table

The following table shows the state of each pin when each protection function operates.

Table 8-1 Protection Function Table

Function	ENA Pin Setting	PG Pin Output	DC/DC Converter Operation	Remarks
Shutdown operation	L	Hi-Z (*1)	Shutdown	It is recommended to connect PG pin to VCC pin or VOUT pin via a pull-up resistor. When setting ENA pin to a low level, Both VCC pin and VOUT pin voltages drop to 0V. Therefore, PG pin outputs 0V.
Nominal operation	H	Hi-Z (*1)	Switching	–
Input under voltage protection (Input UVLO)	H	L	Shutdown	After releasing UVLO state, this IC is automatically reset with soft start.
Output under voltage protection (Output UVP)	H	L	Switching	–
Output over voltage protection (Output OVP)	H	L	Shutdown	–
Output over current protection (Output OCP)	H	L	Switching	OCP operates to drop the output voltage.
Thermal shutdown (TSD)	H	L	Shutdown	After releasing TSD state, this IC is automatically reset with soft start.

*1: PG pin is formed as an open drain structure. The internal MOSFET is in the OFF state.

9. Application Circuit Example and Parts list

Figure 9-1 Application Circuit Example

F_{OSC} = 2.1 MHz
When selecting "VOUT output voltage = 5.0V"
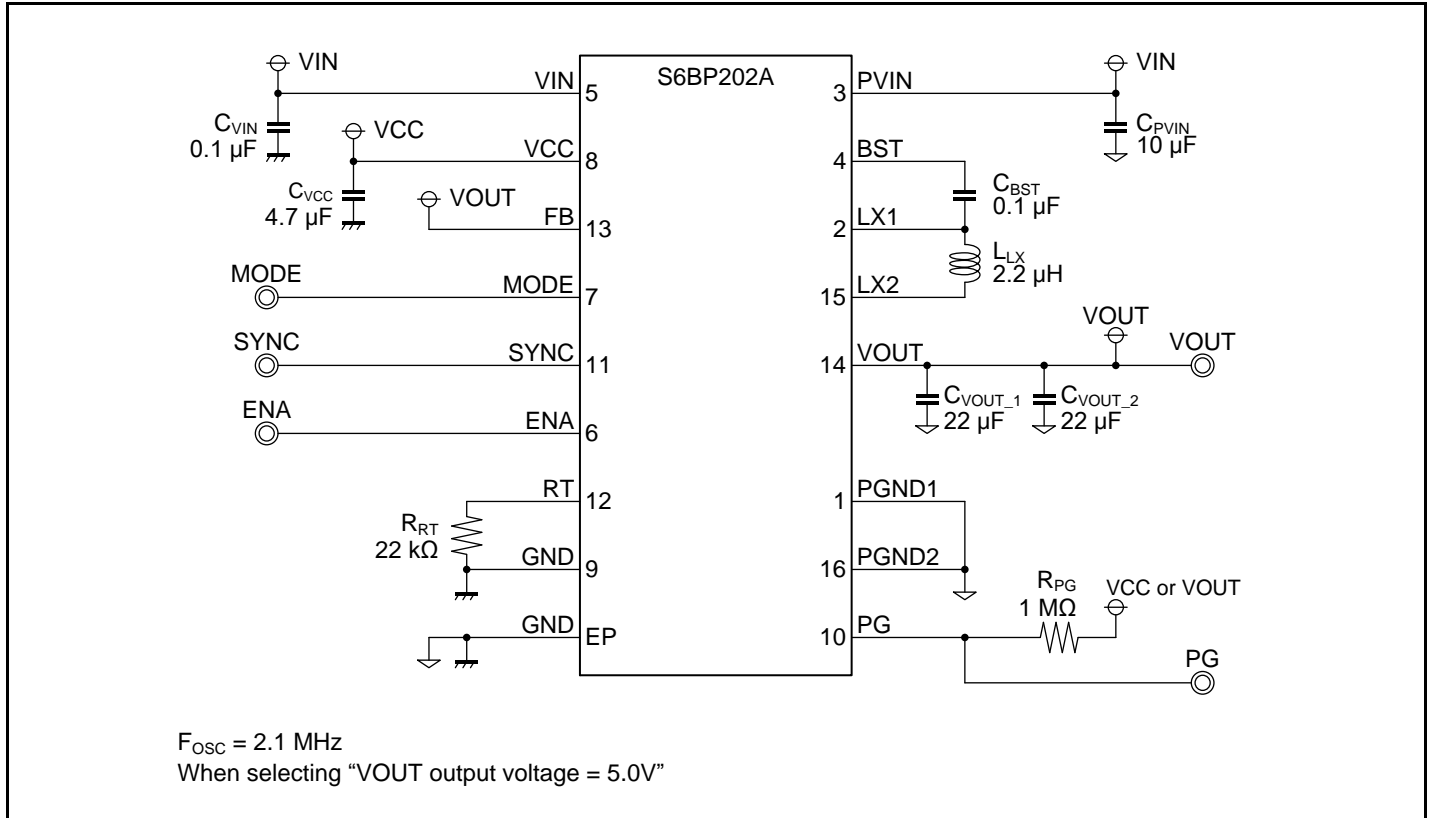
Table 9-1 Parts List

Symbol	Item	Value	Part Number	Vendor	Package Size (W×L×H[mm])	Remarks
C_{VIN}, C_{BST}	Ceramic capacitor	0.1 µF	CGA2B3X7R1H104K050BB	TDK	1.0×0.5×0.5	X7R, Rated voltage: 50 Vdc
C_{PVIN}	Ceramic capacitor	10 µF	CGA9N3X7R1H106K230KB	TDK	5.7×5.0×2.3	X7R, Rated voltage: 50 Vdc
C_{VCC}	Ceramic capacitor	4.7 µF	CGA4J3X7R1C475K125AB	TDK	2.0×1.25×1.25	X7R, Rated voltage: 16 Vdc
C_{VOUT_1}, C_{VOUT_2}	Ceramic capacitor	22 µF	CGA6P1X7R1C226M250AC	TDK	3.2×2.5×2.5	X7R, Rated voltage: 16 Vdc
L_{LX}	Inductor	2.2 µH	CLF7045T-2R2N-D	TDK	7.2×6.9×4.5	DCR: 14.6 mΩ, I_{DC_MAX}: 5.5A
R_{RT}	Resistor	22 kΩ	RK73H1JTTD2202F	KOA	0.8×1.6×0.45	–
R_{PG}	Resistor	1 MΩ	RK73H1JTTD1004F	KOA	0.8×1.6×0.45	–

TDK: TDK Corporation
KOA: KOA Corporation

10. Application Note

10.1 Setting the Operation Conditions

Operation State of DC/DC Convertor When Selecting SYNC_IN

The operation stage of DC/CD converter is set by both MODE pin and SYNC pin.

Table 10-1 Operation State of DC/DC Convertor When Selecting SYNC_IN

MODE Pin	SYNC Pin (Signal Input)	Operation State of DC/DC Convertor
L (*3)	L (*3)	Automatic PWM/PFM switching operation from an internal clock
	External clock input (*5)	Fixed PWM operation with synchronizing signal from an external clock (*2)
	H (*4)	Prohibition of use (*1)
H (*4)	L (*3)	Fixed PWM operation from an internal clock
	External clock input (*5)	Fixed PWM operation with synchronizing signal from an external clock (*2)
	H (*4)	Prohibition of use (*1)

*1: When selecting SYNC_IN and setting SYNC pin to a high level, the quiescent current (I_{VINQ}) is increased.

*2: Set the timing resistance (R_{RT}) to 330 kΩ.

*3: Apply the GND1 or GND2 voltage.

*4: Apply the VOUT voltage.

*5: Apply the VOUT voltage at a high level. Apply the GND1 or GND2 voltage at a low level

Operation State of DC/DC Convertor When Selecting SYNC_OUT

When selecting SYNC_OUT, the phase of SYNC clock output is shifted from an internal clock.

Table 10-2 Operation State of DC/DC Convertor When Selecting SYNC_OUT

MODE Pin	SYNC Pin	Operation State of DC/DC Convertor
L (*1)	Internal clock output	Fixed PWM operation from an internal clock
H (*2)		

*1: Apply the GND1 or GND2 voltage.

*2: Apply the VOUT voltage.

Setting of Switching Frequency (Internal Clock)

The switching frequency (internal clock) can be set by RT resistor, which value is the timing resistance (R_{RT}), connected to RT pin.

Set the timing resistance in a range within the following graph

Figure 10-1 F_{OSC} vs R_{RT} Measured Characteristic

F_{OSC} vs R_{RT} Measured Characteristic

S6BP202AGraph001
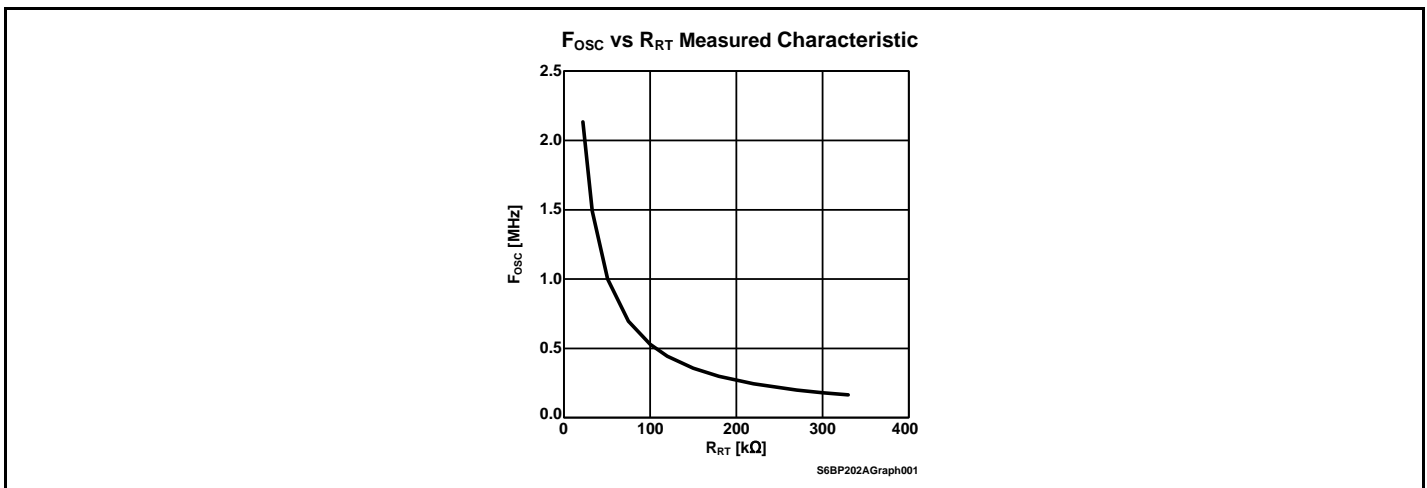
The reference value can be calculated by the following formula.

$$F_{OSC}[Hz] \approx \frac{1}{R_{RT} \times 21.7 \times 10^{-12}}$$

F_{OSC} : Switching frequency [Hz]

R_{RT} : Timing resistance [Ω]

Setting of Soft-start Time

The Soft-start time is determined by the timing resistance (R_{RT}), the value of the resistor connected to RT pin.

$$T_{SS}[s] = \frac{1}{F_{OSC}} \times 2 \times 1024$$

T_{SS} : Soft-start time [s]

F_{OSC} : Switching frequency [Hz]

Consideration of VOUT Maximum Output Current

Make sure the VOUT maximum output current in a range within the following graph.

Figure 10-2 I_{VOUT} vs V_{VIN}
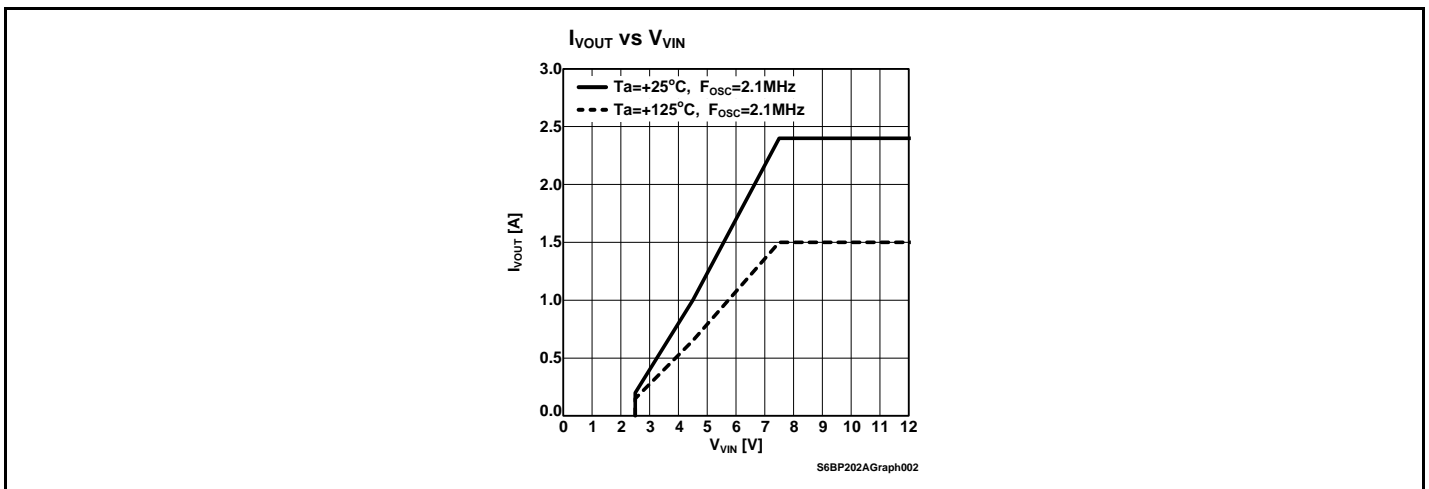
11. Reference Data

The followings are the reference data measured under the conditions shown in "9. Application Circuit Example and Parts list".

Efficiency (Fixed PWM)
V_{OUT} = 5 V, F_{OSC} = 2.1 MHz set, T_A = +25°C, L_{LX} = 2.2 µH, C_{VOUT_1} = C_{VOUT_2} = 22 µF

S6BP202AGraph004-1

Efficiency (Automatic PWM/PFM)
V_{OUT} = 5 V, F_{OSC} = 2.1 MHz set, T_A = +25°C, L_{LX} = 2.2 µH, C_{VOUT_1} = C_{VOUT_2} = 22 µF

S6BP202AGraph004-2

Load Regulation (Fixed PWM)
V_{IN} = 12 V, V_{OUT} = 5 V, F_{OSC} = 2.1 MHz set, L_{LX} = 2.2 µH, C_{VOUT_1} = C_{VOUT_2} = 22 µF

S6BP202AGraph005

Line Regulation (Fixed PWM)
V_{OUT} = 5 V, F_{OSC} = 2.1 MHz set, L_{LX} = 2.2 µH, C_{VOUT_1} = C_{VOUT_2} = 22 µF

S6BP202AGraph006

I_{VINQ} vs V_{VIN} (Automatic PWM/PFM)
V_{OUT} = 5 V, Load Current = 0 A, F_{OSC} = 2.1 MHz set, L_{LX} = 2.2 µH, C_{VOUT_1} = C_{VOUT_2} = 22 µF

S6BP202AGraph008-1

Turn On Response
V_{IN} = 12 V, V_{OUT} = 5 V, Load Current = 0 A, F_{OSC} = 2.1 MHz set, T_A = +25°C, L_{LX} = 2.2 µH, C_{VOUT_1} = C_{VOUT_2} = 22 µF

2 ms/div

S6BP202AGraph009-1

Turn Off Response
V_{IN} = 12 V, V_{OUT} = 5 V, Load Current = 0 A, F_{OSC} = 2.1 MHz set, T_A = +25°C, L_{LX} = 2.2 µH, C_{VOUT_1} = C_{VOUT_2} = 22 µF

2 ms/div

S6BP202AGraph009-2

Load Transient Response

V$_{VIN}$ = 12 V, V$_{VOUT}$ = 5 V, F$_{OSC}$ = 2.1 MHz set, T$_A$ = +25°C,
L$_{LX}$ = 2.2 µH, C$_{VOUT\_1}$ = C$_{VOUT\_2}$ = 22 µF

Automatic PWM/PFM

VOUT
200 mV/div
AC-Coupled

Load
Current
1 A/div

0 A → 2.4 A
/ 10 µs

PG
5 V/div

200 µs/div

S6BP202AGraph010-1

Load Transient Response

V$_{VIN}$ = 12 V, V$_{VOUT}$ = 5 V, F$_{OSC}$ = 2.1 MHz set, T$_A$ = +25°C,
L$_{LX}$ = 2.2 µH, C$_{VOUT\_1}$ = C$_{VOUT\_2}$ = 22 µF

Automatic PWM/PFM

VOUT
200 mV/div
AC-Coupled

Load
Current
1 A/div

2.4 A → 0 A
/ 10 µs

PG
5 V/div

200 µs/div
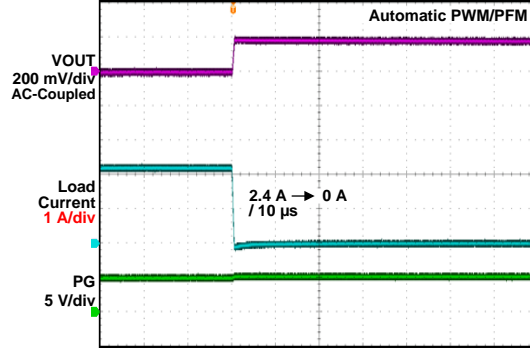
S6BP202AGraph010-2

Cold Crank Line Transient Response

V$_{VOUT}$ = 5 V, Load Current = 0.2 A, F$_{OSC}$ = 2.1 MHz set, T$_A$ = +25°C,
L$_{LX}$ = 2.2 µH, C$_{VOUT\_1}$ = C$_{VOUT\_2}$ = 22 µF

Automatic PWM/PFM

VIN
2 V/div

11 V → 2.5 V
/ 1 ms

2.5 V → 6 V
/ 1 ms

VOUT
200 mV/div
AC-Coupled

PG
5 V/div

4 ms/div
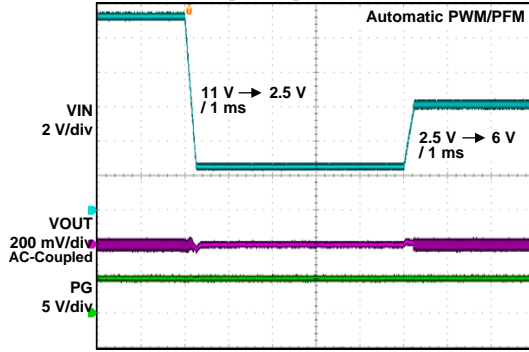
S6BP202AGraph011-1

Load Dump Line Transient Response

V$_{VOUT}$ = 5 V, Load Current = 2.4 A, F$_{OSC}$ = 2.1 MHz set, T$_A$ = +25°C,
L$_{LX}$ = 2.2 µH, C$_{VOUT\_1}$ = C$_{VOUT\_2}$ = 22 µF

Automatic PWM/PFM

VIN
10 V/div

40 V → 11 V
/ 1 ms

11 V → 40 V
/ 1 ms

VOUT
200 mV/div
AC-Coupled

PG
5 V/div

1 ms/div
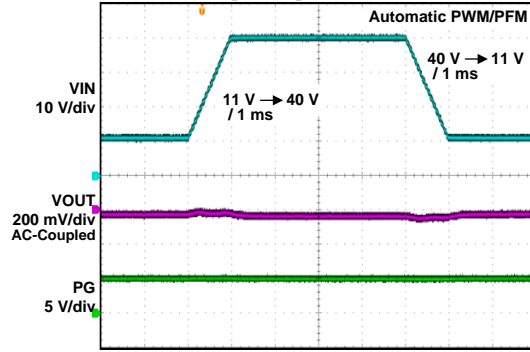
S6BP202AGraph011-2

Switching Waveform

V$_{VIN}$ = 12 V, V$_{VOUT}$ = 5 V, Load Current = 2.4 A, F$_{OSC}$ = 2.1 MHz set,
T$_A$ = +25°C, L$_{LX}$ = 2.2 µH, C$_{VOUT\_1}$ = C$_{VOUT\_2}$ = 22 µF

Automatic PWM/PFM

LX1
2 V/div

1 µs/div
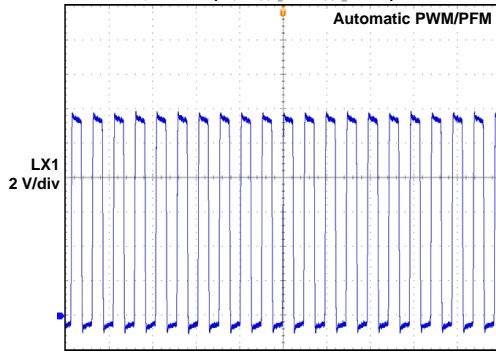
S6BP202AGraph012-1

Ripple Waveform

V$_{VIN}$ = 12 V, V$_{VOUT}$ = 5 V, Load Current = 0 A, F$_{OSC}$ = 2.1 MHz set,
T$_A$ = +25°C, L$_{LX}$ = 2.2 µH, C$_{VOUT\_1}$ = C$_{VOUT\_2}$ = 22 µF

Automatic PWM/PFM

VOUT
50 mV/div
AC-Coupled

10 ms/div
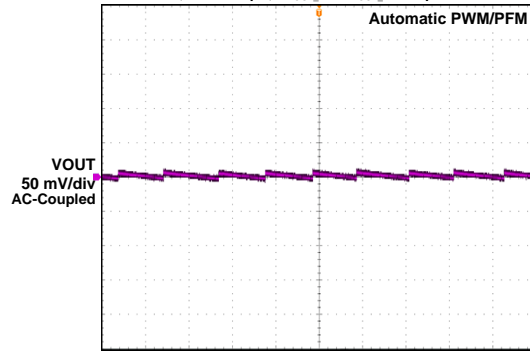
S6BP202AGraph012-2

12. Usage Precaution

Printed circuit board ground lines should be set up with consideration for common impedance.

Take appropriate measures against static electricity.
□ Containers for semiconductor materials should have anti−static protection or be made of conductive material.
□ After mounting, printed circuit boards should be stored and shipped in conductive bags or containers.
□ Work platforms, tools, and instruments should be properly grounded.
□ Working personnel should be grounded with resistance of 250 kΩ to 1 MΩ in serial body and ground.

Do not apply negative voltages.
The use of negative voltages below −0.3 V may make the parasitic transistor activated to the LSI, and can cause malfunctions.

13. RoHS Compliance Information

This product has observed the standard of lead, cadmium, mercury, Hexavalent chromium, polybrominated biphenyls (PBB), and polybrominated diphenyl ethers (PBDE).

14. Ordering Information

Table 14-1 Ordering Information

Order Code	Part Number (MPN) (*1)	Package
1F	S6BP202A1FST2B00A	Plastic ETSSOP16 (0.65 mm pitch), 16-pin (Package Code: SEC016)
1G	S6BP202A1GST2B00A	
4F	S6BP202A4FST2B00A	
7F	S6BP202A7FST2B00A	

MPN: Marketing Part Number
*1: Please contact our sales division for the part numbers (refer to "1. Product Lineup") not mentioned in this table.

Figure 14-1 Ordering Part Number Definitions

S 6B P 2 02 A XX S T2 B 00A
- Fixed on 00A
- Packing: B = 13 inch Tape and Reel
- Package: T2 = ETSSOP, Pure Sn / Low-Halogen
- Reliability Grade: S = 10 ppm
- Preset Condition (Order Code): See "Product Lineup"
- Revision: A = 1st Revision
- Product ID: 02
- Topology: 2 = Switch-Mode Power Supply (Integrated FET)
- Product Type: P = Power Management IC
- Product Class: 6B = Automotive Analog
- Company ID: S = Cypress
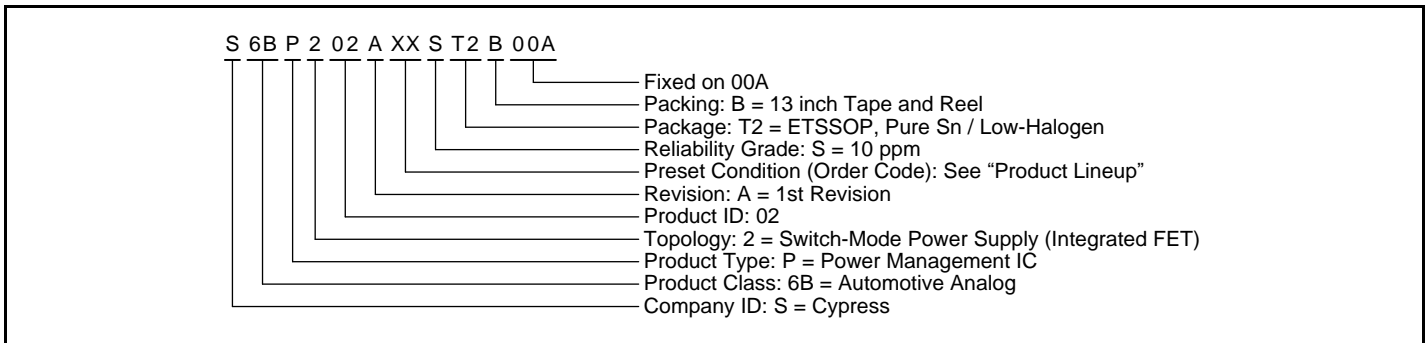
15. Package Dimensions

Package Code: SEC016
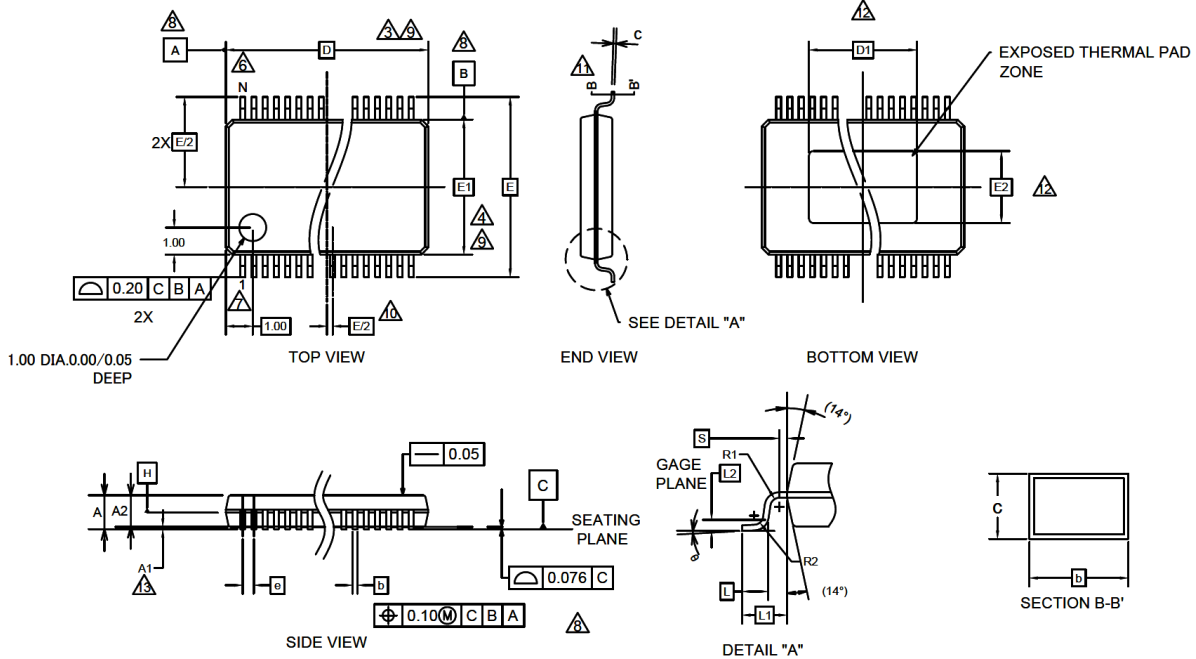
SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	-	-	1.10
A1	0.05	-	0.15
A2	0.85	0.90	0.95
D	4.90	5.00	5.10
E1	4.30	4.40	4.50
E	6.40 BSC		
D1	2.90	3.00	3.10
E2	2.90	3.00	3.10
S	0.20	-	-
R1	0.09	-	-
R2	0.09	-	-
θ	0°	-	8°
c	0.09	-	0.20
b	0.19	-	0.30
L	0.50	0.60	0.70
L1	1.00 REF		
L2	0.25 BSC		
e	0.65 BSC		
N	16		

NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING & TOLERANCES PER ASME. Y14.5M-1994.
3. DIMENSION 'D' DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.
4. DEMENSION 'E1' DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 PER SIDE.
5. DIMENSION 'b' DOES NOT INCLUDE DAMBER PROTRUSION.ALLOWABLE DAMBER PROTRUSIONS SHALL BE 0.07mm TOTAL IN EXCESS OF THE 'b' DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBER CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD SHOULD BE 0.08mm FOR 0.65mm PITCH,0.08mm FOR 0.50mm PITCH AND 0.07mm FOR 0.40mm PITCH PACKAGES.
6. 'N' IS THE MAXIMUM NUMBER OF TERMINAL POSITIONS FOR THE SPECIFIED PACKAGE LENGTH
7. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
8. DATUMS A AND B TO BE DETERMINED AT DATUM PLANE H.
9. DIMENSIONS 'D' AND 'E1' TO BE DETERMINED AT DATUM PLANE H.
10. THIS DIMENSION APPLIES ONLY TO VARIATIONS WITH AN EVEN NUMBER OF LEADS PER SIDE FOR VARIATION WITH AN ODD NUMBER OF LEADS PER SIDE, THE "CENTER" LEAD MUST BE COINCIDENT WITH THE PACKAGE CENTERLINE, DATUM A.
11. CROSS SECTION B-B' TO BE DETERMINED AT 0.10 TO 0.25MM FROM THE LEAD TIP.
12. DIMENSIONS "D1" AND "E2" ARE THERMALLY ENHANCED VARIATIONS. END USER SHOULD VERIFY AVAILABLE SIZE OF EXPOSED PER FOR SPECIFIC DEVICE APPLICATION "D1" AND "E2" DIMENSIONS DO NOT INCLUDE MOLD FLASH.
13. A1 IS DEFINED AS THE VERTICAL CLEARANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

PACKAGE OUTLINE, 16 LEAD ETSSOP
SEC016

002-10769 Rev. **

16. Major Changes

Spansion Publication Number: S6BP202A_DS405-00027

Page	Section	Change Results
Preliminary 0.1		
–	–	Initial release
Preliminary 0.2		
1	Cover page	The sentences of the "Notice to Readers" were changed from "the contents of Full Production" to "the contents of Preliminary".
13	10. Electrical Characteristics	"(TSD)" was added in the table of "10. Electrical Characteristics".

NOTE: Please see "Document History" about later revised information.

Document History

Document Title: S6BP202A, ASSP, 42V, 2.4A, Synchronous Buck-boost DC/DC Converter IC
Document Number: 002-08496

Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	–	HIXT	09/04/2015	New Spec.
*A	5056149	HIXT	12/18/2015	Added Block Diagram Added Figure 15-1 Updated 16. Package Dimensions

*B	5164343	HIXT	03/08/2016	Added "AEC-Q100 compliant (Grade-1)" in Features
				Added Figure 3-1 I/O Pin Equivalent Circuit Diagram
				The followings in 7. Electrical Characteristics were updated.
				    The parameter name of I_{VOUT} was changed from "VOUT output voltage" to "Maximum output current"
				    The max values of I_{VOUT} were moved to the min column.
				Added 11. Development Support
				Added 12. Reference Data
				Deleted the ES part number from Table 15-1

*C	5839054	MASG	07/31/2017	Adapted Cypress new logo.

*D	5909405	HIXT	10/13/2017	Updated to the Cypress naming and format
				    Updated "TSSOP" → "ETSSOP" in Features, Table 14-1 and Figure 14-1
				    Updated 15 Package Dimensions
				Added More Information
				Deleted "11. Development Support" (Moved to More Information)
				Changed the suffix of the Part Number from "000" to "00A" in 1. Product Lineup Table 14-1 and Figure 14-1

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